

Please note that Cypress is an Infineon Technologies Company.

The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

Continuity of document content

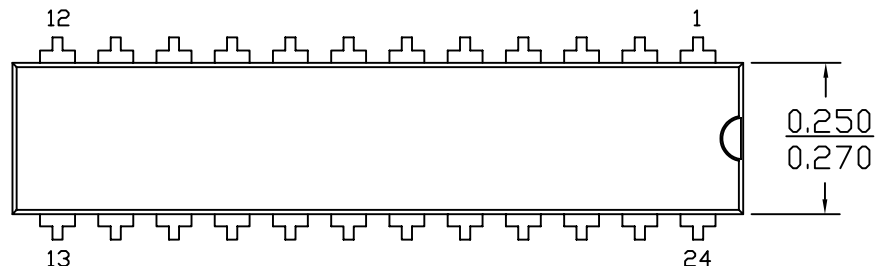
The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

Continuity of ordering part numbers

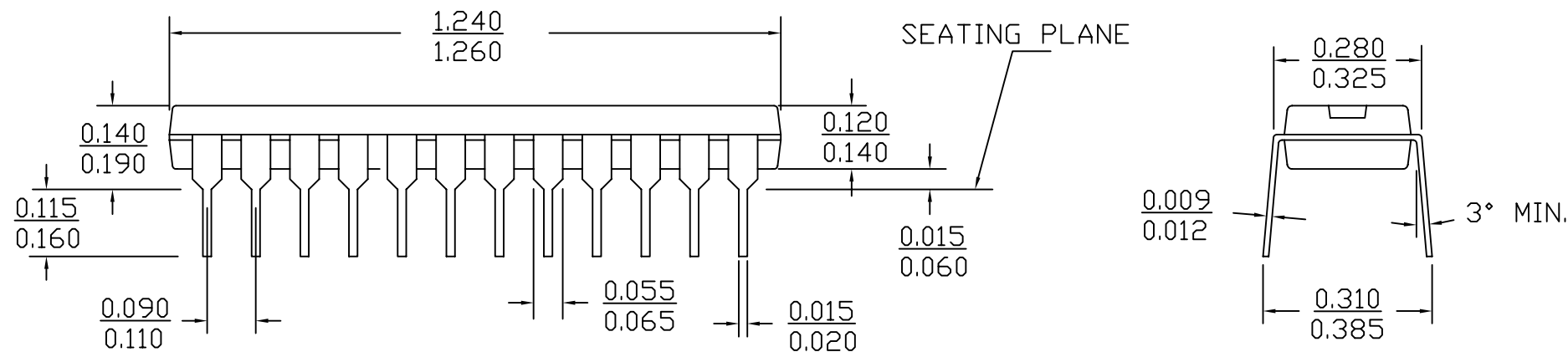
Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.


REVISIONS					
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE
1	-	**	N/A	N/A	N/A
1	-	*A	49370	CHG. TITLE	04/01/97
1	-	*B	120895	REMOVE NOTE A, NOTE B & DIM. TABLE	11/01/02
1	-	*C	2868898	CHANGED TEMPLATE, CHANGE TITLE FROM 24LD (300 MIL) PDIP PKG OUTLINE TO PACKAGE OUTLINE, 24L PDIP 1.260X.270X.140 INCHES P24.3	01/28/10
1	-	*D	3373659	Update spec for sunset review, no changed	09/21/11
1	-	*E	4716659	Update spec for sunset review, no changed	04/08/15

24 Lead (300 Mil) PDIP – P13



DIMENSIONS IN INCHES MIN. MAX.



UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE IN MILLIMETERS STANDARD TOLERANCES ON: DECIMALS .XX ± 0.05 .XXX ± .XXXX + ANGLES ± 1°		DESIGNED BY	N/A	DATE	N/A	 CYPRESS Company Confidential			
		DRAWN BY	HTN	DATE	11/01/02				
		CHECKED BY	TSV	DATE	01/28/10	TITLE PACKAGE OUTLINE, 24L PDIP 1.260X.270X.140 INCHES P24.3			
		APPROVED BY	QAD	DATE	01/28/10				
MATERIAL	N/A	APPROVED BY	JGUA	DATE	01/28/10	SIZE A	PART NO. P24.3	DWG NO 51-85013	REV *E
FINISH	N/A	APPROVED BY	N/A	DATE	N/A	SCALED TO FIT		N/A	SHEET 1 of 1

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